



7 2 5-7-01 69

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Akram et al.

**Serial No.:** 09/832,160

**Filed:** April 9, 2001

**For:** WAFER-LEVEL PACKAGE AND  
METHODS OF FABRICATING

**Examiner:** Unknown

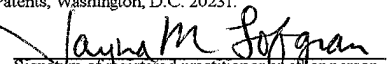
**Group Art Unit:** Unknown

**Attorney Docket No.:** 3846.2US  
(98-0796.2)

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

April 24, 2001  
Date of Deposit

  
Signature of registered practitioner or other person  
having reasonable basis to expect mailing to occur  
on date of deposit shown pursuant to 37 C.F.R.  
§ 1.8(a)(1)(ii)

Jayna M. Lofgran  
Typed/printed name of person whose signature is  
contained above

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Box NON-FEE  
Commissioner for Patents  
Washington, D.C. 20231

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 be considered by the Examiner and made of record. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a).

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as



Serial No. 09/832,160

defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

DOCUMENTS

U.S. Patent Documents

<u>U.S. Patent No.</u>	<u>Issue Date</u>	<u>Inventor</u>
5,977,641	11/02/1999	Takahashi et al.
6,117,539	09/12/2000	Crotzer et al.

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed within three (3) months of the filing date of the above-identified application.

Respectfully submitted,

*Brick G. Power*

Brick G. Power  
Registration No. 38,581  
Attorney for Applicants  
TRASKBRITT, PC  
P. O. Box 2550  
Salt Lake City, Utah 84110-2550  
Telephone: (801) 532-1922

Date: April 24, 2001  
BGP/jml

Enclosures: Form PTO-1449  
Copy of documents cited

N:\2269\3846.2\lds (1st supp).wpd